Emitter common(dual digital transistors)

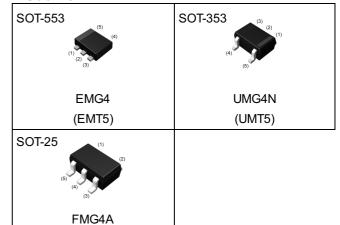
**Datasheet** 

Parameter	DTr1 and DTr2
$V_{\sf CEO}$	50V
I <sub>C</sub>	100mA
R <sub>1</sub>	10kΩ

### Features

- 1)Two DTC114T chips in a EMT or UMT or SMT package.
- 2) Mounting cost and area can be cut in half.

## Outline

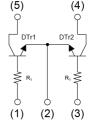


## •Inner circuit

### EMG4 / UMG4N

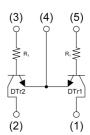
(SMT5)

- (1) DTr1 Base
- (2) DTr1 / DTr2 Emitter
- (3) DTr2 Base
- (4) DTr2 Collector
- (5) DTr1 Collector



#### FMG4A

- (1) DTr1 Collector
- (2) DTr2 Collector
- (3) DTr2 Base
- (4) DTr1 / DTr2 Emitter
- (5) DTr1 Base



# Application

INVERTER, INTERFACE, DRIVER

# Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
EMG4	SOT-553 (EMT5)	1616	T2R	180	8	8000	G4
UMG4N	SOT-353 (UMT5)	2021	TR	180	8	3000	G4
FMG4A	SOT-25 (SMT5)	2928	T148	180	8	3000	G4

# ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

# <For DTr1 and DTr2 in common>

Parameter			Symbol	Values	Unit	
Collector-base voltage			$V_{CBO}$	50	V	
Collector-emitter voltage			$V_{CEO}$	50	V	
Emitter-base voltage		$V_{\text{EBO}}$	5	V		
Collector current			I <sub>C</sub>	100	mA	
	EMG4		P <sub>D</sub> *1*2	150		
Power dissipation	UMG4N		P <sub>D</sub> *1*2	150	mW/Total	
FMG4A			P <sub>D</sub> *1*3	300		
Junction temperature			T <sub>j</sub>	150	°C	
Range of storage temper	Range of storage temperature			-55 to +150	°C	

# ● Electrical characteristics (T<sub>a</sub> = 25°C)

# <For DTr1 and DTr2 in common>

Darameter	Cymabal	Conditions	Values			Unit
Parameter	Symbol Conditions		Min.	Тур.	Max.	Unit
Collector-base breakdown voltage	BV <sub>CBO</sub>	I <sub>C</sub> = 50μA	50	-	-	V
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>C</sub> = 1mA	50	1	1	V
Emitter-base breakdown voltage	BV <sub>EBO</sub>	I <sub>E</sub> = 50μA	5	-	-	V
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = 50V	-	-	500	nA
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = 4V	-	-	500	nA
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = 10mA, I <sub>B</sub> = 1mA	-	1	300	mV
DC current gain	h <sub>FE</sub>	$V_{CE} = 5V$ , $I_C = 1mA$	100	250	600	-
Input resistance	R <sub>1</sub>	-	7	10	13	kΩ
Transition frequency	f <sub>T</sub> *4	V <sub>CE</sub> = 10V, I <sub>E</sub> = -5mA, f = 100MHz	-	250	-	MHz

<sup>\*1</sup> Each terminal mounted on a reference land.



<sup>\*2 120</sup>mW per element must not be exceeded.

<sup>\*3 200</sup>mW per element must not be exceeded.

<sup>\*4</sup> Characteristics of built-in transistor.

# ● Electrical characteristic curves (T<sub>a</sub> = 25°C)

<For DTr1 and DTr2 in common>

Fig.1 Grounded Emitter Propagation Characteristics

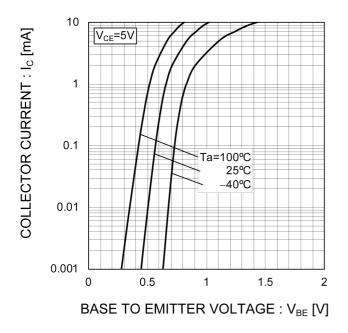


Fig.2 Grounded Emitter Output Characteristics

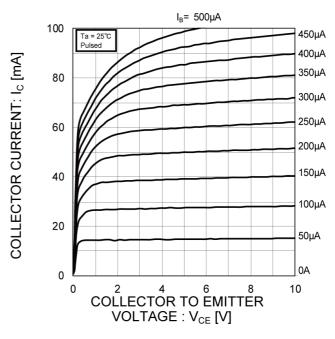


Fig.3 DC Current Gain vs. Collector Current

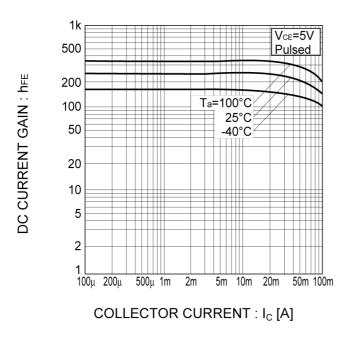
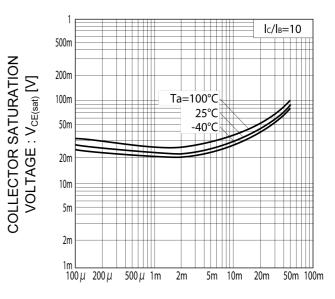
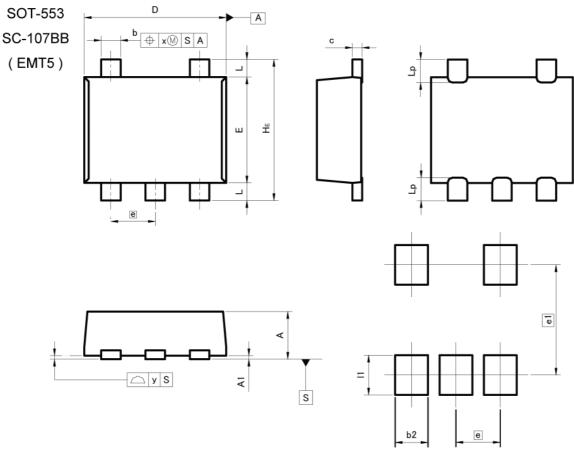


Fig.4 Collector-Emitter Saturation Voltage vs. Collector Current



# Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

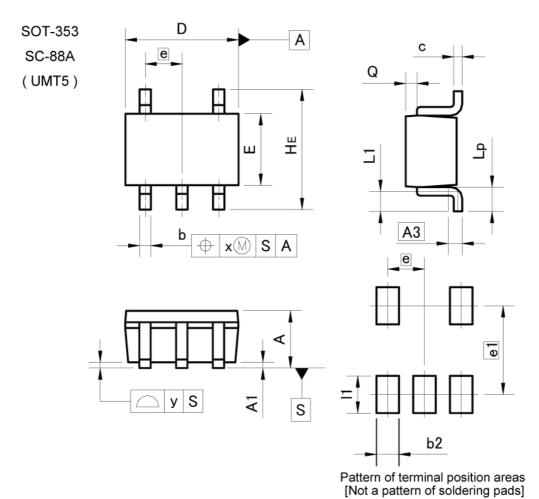
DIM	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
Α	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
С	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	1.10	1.30	0.043	0.051
е	0.	50	0.020	
HE	1.50	1.70	0.059	0.067
L	0.10	0.30	0.004	0.012
Lp	_	0.35	-	0.014
х	_	0.10	_	0.004
У	_	0.10	_	0.004

DIM	MILIM	ETERS	INCHES	
DIW	MIN	MAX	MIN	MAX
b2	ī	0.37	ı	0.015
e1	1.25		0.0	49
11	_	0.45	-	0.018

Dimension in mm/inches



# Dimensions



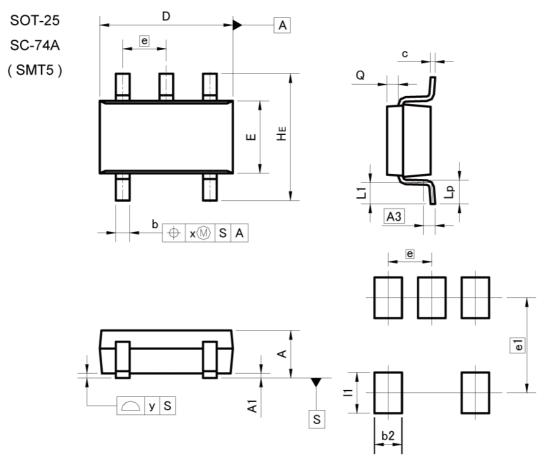
DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.80	1.00	0.031	0.039
A1	0.00	0.10	0.000	0.004
A3	0.:	25	0.0	10
b	0.15	0.30	0.006	0.012
С	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
Е	1.15	1.35	0.045	0.053
е	0.	65	0.026	
HE	2.00	2.20	0.079	0.087
L1	0.20	0.50	0.008	0.020
Lp	0.25	0.55	0.010	0.022
Q	0.10	0.30	0.004	0.012
Х	-	0.10	-	0.004
У		0.10	-	0.004

DIM	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
b2	- 7	0.40	-	0.016
e1	1.55		0.0	61
11	_	0.65	-	0.026

Dimension in mm/inches



# Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	1.00	1.30	0.039	0.051
A1	0.00	0.10	0.000	0.004
A3	0.:	25	0.0	10
b	0.25	0.40	0.010	0.016
С	0.09	0.25	0.004	0.010
D	2.80	3.00	0.110	0.118
Е	1.50	1.80	0.059	0.071
е	0.9	95	0.037	
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.20	0.30	0.008	0.012
x		0.20	<del>-</del>	0.008
у	- /,	0.10	-//	0.004

DIM	MILIMETERS		INCHES	
DIM	MIN		MIN	MAX
b2	- 0	0.60	- 0	0.024
e1	2.10		0.0	83
11	<del></del> 0	0.90		0.035

Dimension in mm/inches



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  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
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  - [h] Use of the Products in places subject to dew condensation
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- 8. Confirm that operation temperature is within the specified range described in the product specification.
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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
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  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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